



SN IR/Green/UV Series Sub-nanosecond Lasers

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Overview

A pioneer of intracavity UV and green generation with 28+ years of manufacturing experience and tens of thousands of shipments worldwide, Photronics Industries offers the broadest sub-nanosecond (ns) product selection from 30W to 100W at 1064nm, 16W to 60W at 532nm and 10W to 40W at 355nm in water cooled versions and 10W at 1064nm, 5W at 532nm and 3W at 355nm in an air-cooled version.

The SN Series fills the gap for high power laser availability in the subnanosecond (i.e., ~50ps to 5ns) pulse width range. Such lasers have been identified as beneficial for a variety of micromachining and LIDAR applications, but until now, have been limited to only a few Watts of average power. Photronics Industries now offers a unique high intensity (i.e., high brightness/high peak power) sub-ns laser alternative for novel laser-based material processing, research and development, as well as, scientific applications. The longer pulse widths of the SN laser allows it to be run at higher pulse energies at lower rep rates than conventional 10 to 20ps lasers.

Features

- ❖ *Up to 100W of power at 1064nm*
- ❖ *Up to 3mJ of pulse energy at 1064nm*
- ❖ *Sub ns Pulse Width*
 - *specifiable from ~50ps to 5ns*
- ❖ *Repetition rate from Single Shot to 8MHz*
- ❖ *Excellent beam quality (M2<1.3)*
- ❖ *Air-cooled and Closed loop chilled versions*
- ❖ *Small compact all-in-one form factor*
- ❖ *Diode pumped technology*
- ❖ *Harmonic options available (i.e., 532 & 355nm)*
- ❖ *Low jitter <500ps*
- ❖ *Burst Mode*

Applications

- ❖ *Solar cell processing (PERC, CIGS, etc.)*
- ❖ *Glass, sapphire, ceramic cutting, scribing, and ablative drilling*
- ❖ *Low K wafers and LED substrates scribing/dicing*
- ❖ *Via hole drilling*
- ❖ *PCB processing*
- ❖ *ITO patterning/FPD processing*
- ❖ *Intraglass/subsurface marking*
- ❖ *LIDAR*
- ❖ *Bathymetry CZMIL*
- ❖ *Cryosphere and Biomass Measurements*



System Specifications

| Model | SN 1064-10 | SN 1064-30 | SN 1064-70 | SN 1064-100 |
|--|---|---------------------------------|------------|---------------------------------|
| Output Characteristics | | | | |
| Wavelength (nm) | 1064 | | | |
| Average Power (W) @ 1 MHz ^a | 10 | 30 | 70 | 100 |
| Pulse Width (ps) ^b | ~500 | | | |
| Repetition Rate ^c | Single shot to 8 MHz | | | |
| Pulse to Pulse Stability | ~2% rms at 1 MHz | | | |
| Long Term Stability ^d | ≤ 1% rms | | | |
| Beam Characteristics | | | | |
| Beam Diameter at exit | ~1 mm | | | |
| Spatial Mode (M2) | TEM ₀₀ M ² <1.3 | | | |
| Beam Pointing Stability | < 50 μrad | | | |
| Beam Circularity | ≥ 90% | | | |
| Beam Divergence | < 3 mrad | | | |
| Beam Bore Sight Accuracy | ≤ 1 mm Lateral (to specified exit location); ≤ 6 mrad Angular (to specified exit direction) | | | |
| Operating Specifications | | | | |
| Interface | Ethernet / RS 232 / GUI / External TTL Triggering | | | |
| Warm-up Time | < 15 min | | | |
| Electrical Requirement | 100 to 240 V AC; or 32 V DC, 15 A | | | |
| Power Consumption | ~120 W | < 600 W (Excluding Chiller) | | |
| Ambient Temperature | 15°C to 30°C (59°F to 86°F) Operating Range, RH 90% Max, non-condensing | | | |
| Physical Characteristics | | | | |
| Dimensions | 8.5 in x 3.75 in x 15 in (WxLxH) | 10 in x 3.75 in x 24 in (WxLxH) | | 12 in x 3.75 in x 24 in (WxLxH) |
| Weight | ~31 lbs | ~58 lbs | | ~74 lbs |
| Vibration | Up to 3g | | | |
| Cooling System | Air-cooled | Closed Loop Chiller | | |

a) At nominal pulse width

b) Pulse widths down to ~50 ps and up to 5 ns available upon request

c) Lower repetition rates, down to single shot, achieved by selecting higher repetition rate pulses with the AOM

d) 8 hours ± 3°C



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International, Inc.

| Model | SN 532-5 | SN 532-16 | SN 532-40 | SN 532-60 |
|--|---|---------------------------------|-----------|---------------------------------|
| Output Characteristics | | | | |
| Wavelength (nm) | 532 | | | |
| Average Power (W) @ 1 MHz ^a | 5 | 16 | 40 | 60 |
| Pulse Width (ps) ^b | ~350 | | | |
| Repetition Rate ^c | Single shot to 8 MHz | | | |
| Pulse to Pulse Stability | ~2% rms at 1 MHz | | | |
| Long Term Stability ^d | ≤ 1% rms | | | |
| Beam Characteristics | | | | |
| Beam Diameter at exit | ~1 mm | ~2 mm | | |
| Spatial Mode (M ²) | TEM ₀₀ M ² <1.3 | | | |
| Beam Pointing Stability | < 50 μrad | | | |
| Beam Circularity | ≥ 90% | | | |
| Beam Divergence | < 3 mrad | < 2 mrad | | |
| Beam Bore Sight Accuracy | ≤ 1 mm Lateral (to specified exit location); ≤ 6 mrad Angular (to specified exit direction) | | | |
| Operating Specifications | | | | |
| Interface | Ethernet / RS 232 / GUI / External TTL Triggering | | | |
| Warm-up Time | < 15 min | | | |
| Electrical Requirement | 100 to 240 V AC; or 32 V DC, 15 A | | | |
| Power Consumption | ~120 W | < 600 W (Excluding Chiller) | | |
| Ambient Temperature | 15°C to 30°C (59°F to 86°F) Operating Range, RH 90% Max, non-condensing | | | |
| Physical Characteristics | | | | |
| Dimensions | 8.5 in x 3.75 in x 15 in (WxLxH) | 10 in x 3.75 in x 24 in (WxLxH) | | 12 in x 3.75 in x 24 in (WxLxH) |
| Weight | ~31 lbs | ~58 lbs | | ~74 lbs |
| Vibration | Up to 3g | | | |
| Cooling System | Air-cooled | Closed Loop Chiller | | |

a) At nominal pulse width

b) Pulse widths down to ~50 ps and up to 5 ns available upon request

c) Lower repetition rates, down to single shot, achieved by selecting higher repetition rate pulses with the AOM

d) 8 hours ± 3°C

| Model | SN 355-3 | SN 355-10 | SN 355-25 | SN 355-40 |
|--|---|---------------------------------|-----------|---------------------------------|
| Output Characteristics | | | | |
| Wavelength (nm) | 355 | | | |
| Average Power (W) @ 1 MHz ^a | 3 | 10 | 25 | 40 |
| Pulse Width (ps) ^b | ~300 | | | |
| Repetition Rate ^c | Single shot to 8 MHz | | | |
| Pulse to Pulse Stability | ~2% rms at 1 MHz | | | |
| Long Term Stability ^d | ≤ 1% rms | | | |
| Beam Characteristics | | | | |
| Beam Diameter at exit | ~1 mm | ~2 mm | | |
| Spatial Mode (M ²) | TEM ₀₀ M ² <1.3 | | | |
| Beam Pointing Stability | < 50 μrad | | | |
| Beam Circularity | ≥ 90% | | | |
| Beam Divergence | < 3 mrad | < 1.5 mrad | | |
| Beam Bore Sight Accuracy | ≤ 1 mm Lateral (to specified exit location); ≤ 6 mrad Angular (to specified exit direction) | | | |
| Operating Specifications | | | | |
| Interface | Ethernet / RS 232 / GUI / External TTL Triggering | | | |
| Warm-up Time | < 15 min | | | |
| Electrical Requirement | 100 to 240 V AC; or 32 V DC, 15 A | | | |
| Power Consumption | ~120 W | < 600 W (Excluding Chiller) | | |
| Ambient Temperature | 15°C to 30°C (59°F to 86°F) Operating Range, RH 90% Max, non-condensing | | | |
| Physical Characteristics | | | | |
| Dimensions | 8.5 in x 3.75 in x 15 in (WxLxH) | 10 in x 3.75 in x 24 in (WxLxH) | | 12 in x 3.75 in x 24 in (WxLxH) |
| Weight | ~31 lbs | ~58 lbs | | ~74 lbs |
| Vibration | Up to 3g | | | |
| Cooling System | Air-cooled | Closed Loop Chiller | | |

a) At nominal pulse width

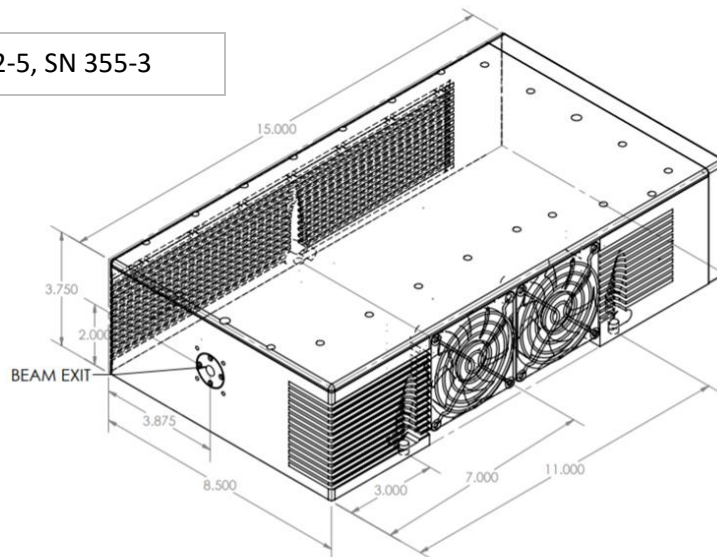
b) Pulse widths down to ~50 ps and up to 5 ns available upon request

c) Lower repetition rates, down to single shot, achieved by selecting higher repetition rate pulses with the AOM

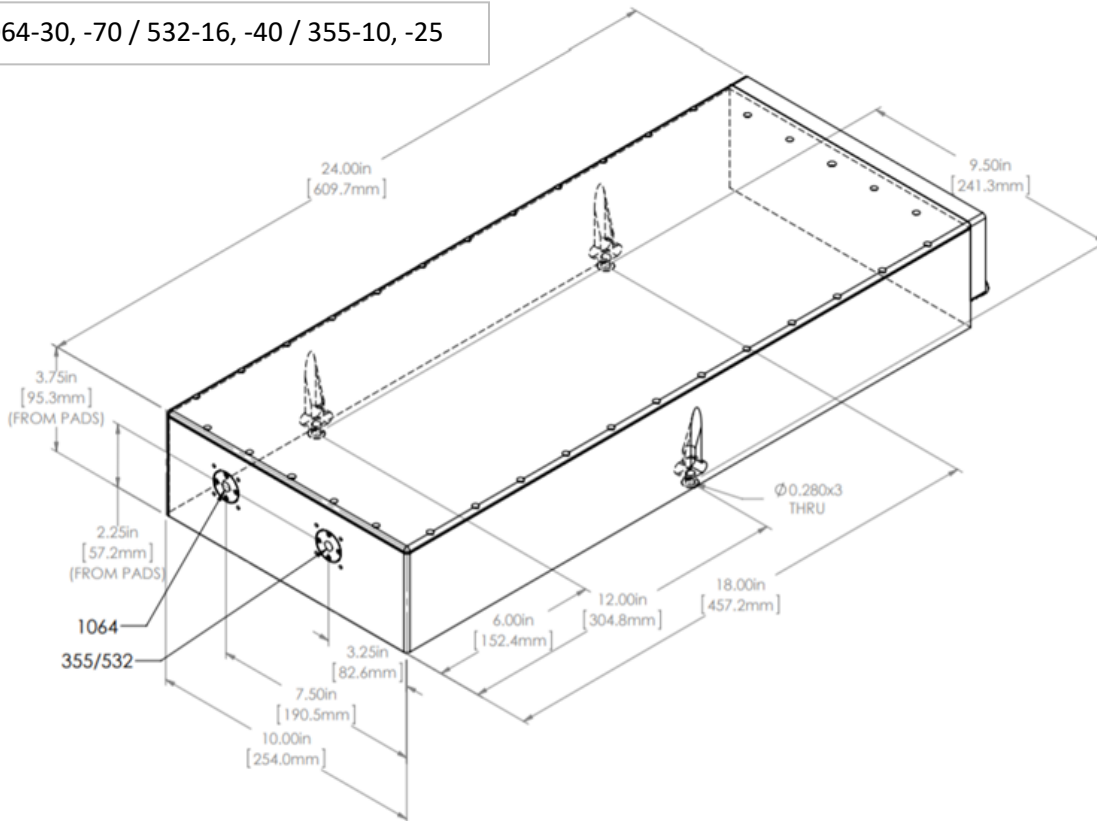
d) 8 hours ± 3°C

Dimensional Drawings

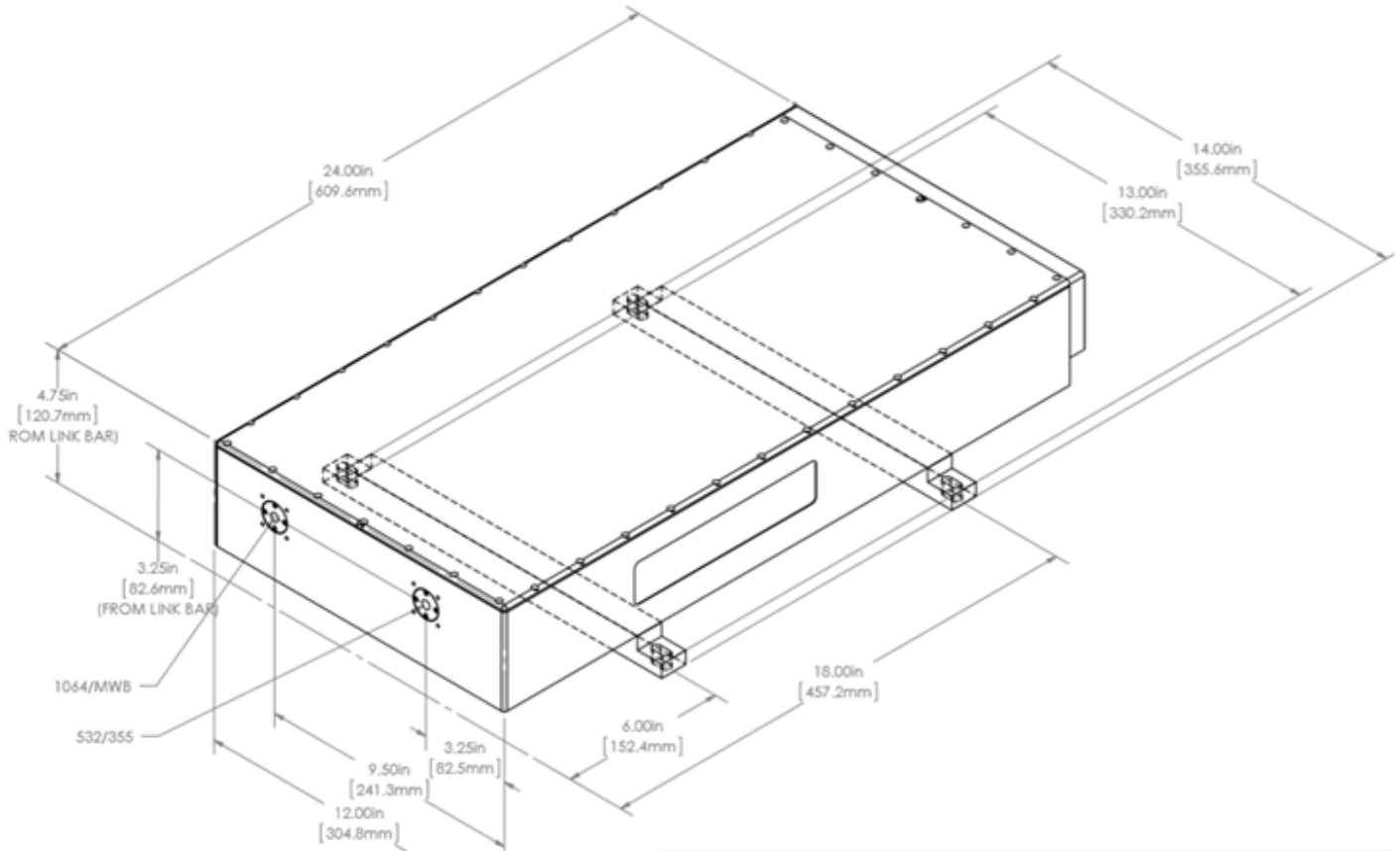
SN 1064-10, SN 532-5, SN 355-3



SN 1064-30, -70 / 532-16, -40 / 355-10, -25



SN 1064-100 / 532-60 / 355-40



Due to Photonics Industries' commitment to continuous product improvement, specifications and drawings are subject to change without notice.

Photonics Industries conforms to provisions of US 21 CFR 1040.10 & 1040.11 and is made under one or more US patents listed below: 9,531,147, 8,817,831, 7,869,471, 7,346,092, 7,082,149, 7,079,557, 6,999,483, 6,980,574, 6,961,355, 6,842,293, 6,762,405, 6,690,692, 6,587,487, 6,584,134, 6,366,596, 6,356,578, 6,327,281, 6,246,707, 6,229,829, 6,108,356, 6,061,370, 6,028,620, 5,936,983, 5,898,717 and Pending Patents

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